

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	197	257/778.ccls and (@ad<"20010829") and (inductor or inductance)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 08:50
L2	394	(@ad<"20010829") and (wafer with (inductor or inductance))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 08:52
L3	95	(@ad<"20010829") and ((wafer and (inductor or inductance)) with (recess or pit or cavity or trench or via or channel))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 08:55
L4	117	(@ad<"20010829") and ((wafer and (inductor or inductance)) with (hole or openig or recess or pit or cavity or trench or via or channel))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 08:55
L5	137	(@ad<"20010829") and ((wafer and (inductor or inductance)) with (hole or opening or recess or pit or cavity or trench or via or channel))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 10:10
L6	889	(@ad<"20010829") and (((chip or die) and (inductor or inductance))) with (hole or opening or recess or pit or cavity or trench or via or channel))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 09:26
L7	485	(@ad<"20010829") and (((chip or die) and inductor)) with (hole or opening or recess or pit or cavity or trench or via or channel))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 09:26
L8	469	L7 not L5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 09:27

L9	98	(@ad<"20010829") and 257/531, 522,277.ccls. and wafer and inductor	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/15 10:11
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